Printed Electronics Helix Launch Event

21 September





Novel applications for In-mold Electronics



MADRAS project

Developing advanced materials to be promptly processed via In-mold Electronics to fabricate a new generation of plastronic products to make OLAE-based devices more affordable and durable.



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Materials Improvement

Five materials with enhanced electrical properties:

- Nanocellulose substrate
- •Ag NWs and Ag NPs-based ink
- PEDOT:PSS-based ink
- •PEDOT:PSS:WO_x-based ink

Processing by In-Mould Electronics

Allow high speed manufacturing methodology

- Design and printing of devices
- Assembly of control circuits
- Thermoforming and injection moulding processing

Demo product manufacturing

Materials and processes applied to three cases:

- Flexible geolocation tag
- Photodetector fingerprint sensor
- In-mold solar modules
- Upscaling of materials and IME processing

Validation in relevant environment

- Geolocalization of the tag tested in an operative warehouse
- Biometric readers incorporated into testing scooters





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Outcomes



Novel conductive and semiconducting inks fit for IME

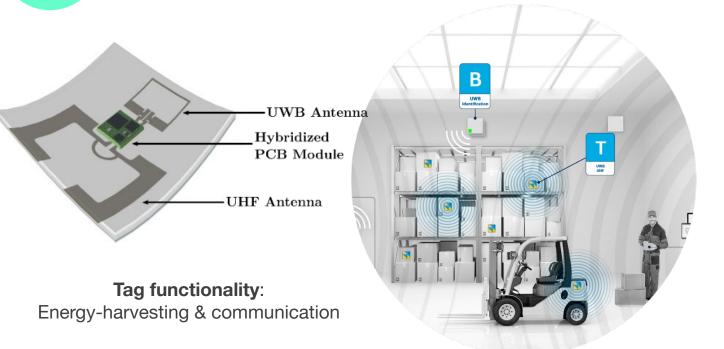
Nanocellulose-based substrates for printed electronics

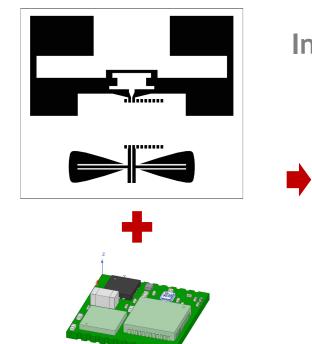
In-mould encapsulation of PCBs on printed circuits

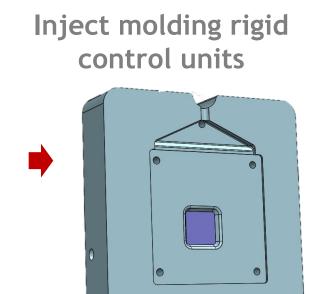
IME applied on tags with embedded antennas

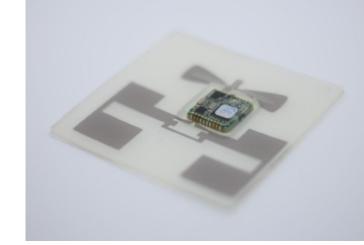
3D-shaped photosensing imagers

IME applied on printed optoelectronics (OPD, OPV) A geotracking flexible tag for the packaging and logistics sector





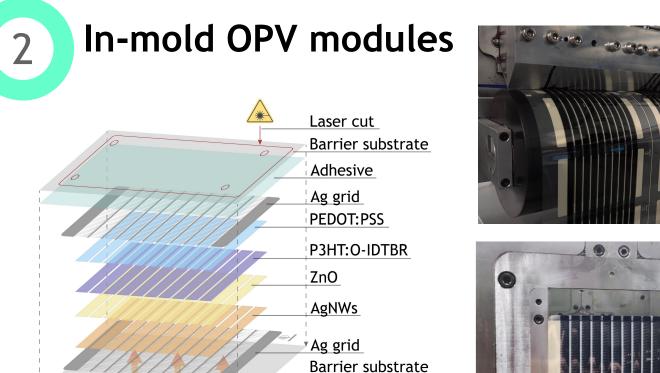


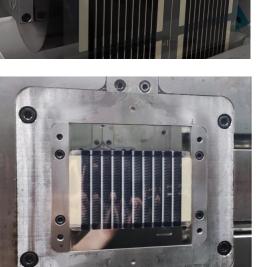


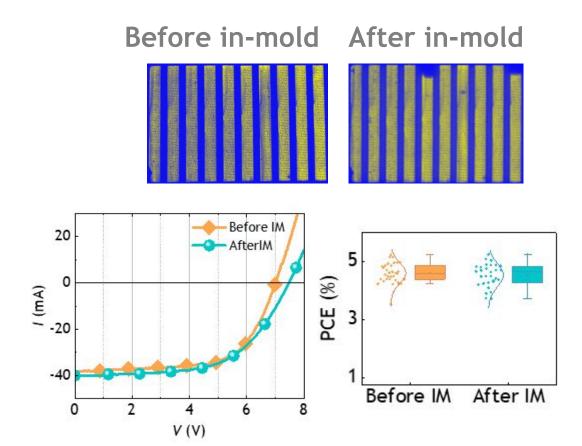
- Protection to antennas and control units
- Highly performing inks

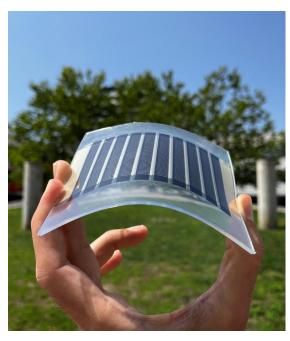
Flexibility

Compatibility between nanocellulose and injected TPU









- ✓ Large-scale fabrication of OPV modules embedded into structural plastic parts
- ✓ No efficiency losses
- ✔ Process yield of 90%



